HSD Cable Connectors (Double) IAM-L56, L57, L58, L59

Connectors

FEATURES

- 1. Capable of high speed data transmission such as USB2.0, LVDS, and Ethernet, etc.
- 2. Selectable variations of mounting requirements. (Straight type / Angle type.)
- 3. Each coding (mating key) is available.
- 4. Compliant with RoHS Directive.



SPECIFICATIONS

ELECTRICAL CHARACTERISTICS

IAM-L56/L58 (Straight type)

| Rated Voltage | 100V DC | |
|--------------------------|------------------------------|--|
| Rated Current | 1.5A DC | |
| Characteristic Impedance | 100Ω | |
| Insertion Loss | ≦0.1dB to 1GHz | |
| Return Loss | ≦-20dBto1GHz ≦-17dBto2GHz | |

IAM-L57/L59 (Angle type)

| Rated Voltage | $100 \mathrm{V} \mathrm{DC}$ | | |
|--------------------------|--|--|--|
| Rated Current | 1.5A DC | | |
| Characteristic Impedance | 100Ω | | |
| Insertion Loss | ≦0.01dB to 500MHz | | |
| Return Loss | $ \leq -25 dB to 100 MHz \\ \leq -15 dB to 500 MHz \\ \leq -10 dB to 1 GHz $ | | |

MECHANICAL CHARACTERISTICS

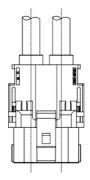
| Life (Mating Cycle) | 25 times |
|------------------------|-----------|
| Total Insertion Force | ≦30N |
| Total Withdrawal Force | 5N to 25N |

MATERIAL & FINISH

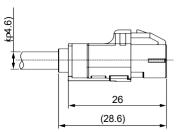
| C | omponent Parts | Material | Finish |
|--|-----------------|--------------|----------------------------|
| IAM-L56 Straight | Signal Pin | Copper alloy | Gold selective plating |
| | Insulator | LCP resin | Black |
| | Coded Housing | PBT resin | Corresponds to each coding |
| | Secondary Lock | PBT resin | Pink |
| | Outer Conductor | Zinc alloy | Ni plating |
| | Spring Basket | Copper alloy | Ni plating |
| | Support Crimp | Copper alloy | Tin reflow plating |
| IAM-L57 Angle | Signal Pin | Copper alloy | Gold selective plating |
| | Insulator | LCP resin | Black |
| | Coded Housing | PBT resin | Corresponds to each coding |
| | Secondary Lock | PBT resin | Pink |
| | Outer Conductor | Zinc alloy | Ni plating |
| | Spring Basket | Copper alloy | Ni plating |
| | Support Crimp | Copper alloy | Tin reflow plating |
| | Press Cap | Copper alloy | Tin reflow plating |
| IAM-L58 Straight Secon Outer Spring | Signal Pin | Copper alloy | Gold selective plating |
| | Insulator | LCP resin | Black |
| | Coded Housing | PBT resin | Corresponds to each coding |
| | Secondary Lock | PBT resin | Pink |
| | Outer Conductor | Zinc alloy | Ni plating |
| | Spring Basket | Copper alloy | Ni plating |
| | Support Crimp | Copper alloy | Tin reflow plating |
| IAM-L59 S Angle O S | Signal Pin | Copper alloy | Gold selective plating |
| | Insulator | LCP resin | Black |
| | Coded Housing | PBT resin | Corresponds to each coding |
| | Secondary Lock | PBT resin | Pink |
| | Outer Conductor | Zinc alloy | Ni plating |
| | Spring Basket | Copper alloy | Ni plating |
| | Support Crimp | Copper alloy | Tin reflow plating |
| | Press Cap | Copper alloy | Tin reflow plating |

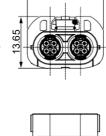
DIMENSIONS

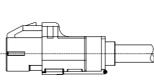
IAM-L56



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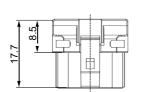




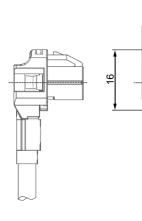


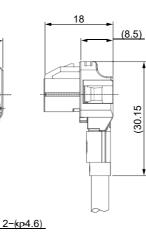
Unit : mm

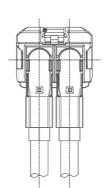
IAM-L57



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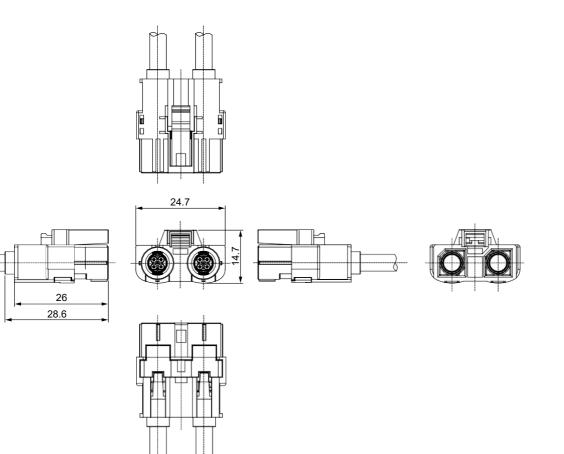


Unit : mm

IAM-L58

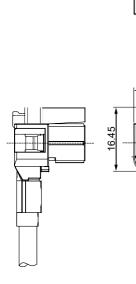
(cp4.6)

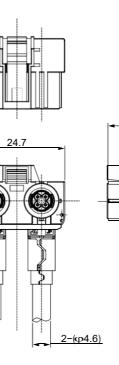
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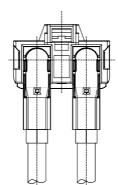


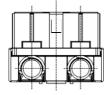
IAM-L59











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Unit : mm